



Material Content Data Sheet



Halogen-Free

Sales Product Name	2ED21094S06J	Issued	18. August 2021
MA#	MA005398594		
Package	PG-DSO-14-70	Weight*	138.36 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.438	1.04	1.04	10397	10397
leadframe	inorganic material	phosphorus	7723-14-0	0.014	0.01		104	
	non noble metal	zinc	7440-66-6	0.057	0.04		415	
	non noble metal	iron	7439-89-6	1.150	0.83		8308	
	non noble metal	copper	7440-50-8	46.675	33.74	34.62	337351	346178
wires	noble metal	palladium	7440-05-3	0.001			4	
	non noble metal	copper	7440-50-8	0.052	0.04	0.04	379	383
encapsulation	organic material	carbon black	1333-86-4	0.347	0.25		2508	
	plastics	epoxy resin	-	12.580	9.09		90927	
	inorganic material	silicondioxide	60676-86-0	73.834	53.36	62.70	533648	627083
leadfinish	non noble metal	tin	7440-31-5	1.226	0.89	0.89	8862	8862
plating	noble metal	silver	7440-22-4	0.307	0.22	0.22	2215	2215
glue	plastics	acrylic resin	-	0.149	0.11		1074	
	noble metal	silver	7440-22-4	0.527	0.38	0.49	3808	4882
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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